

COMPLEMENTARY PAIR ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Features

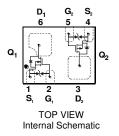
- Low On-Resistance
- Low Gate Threshold Voltage V_{GS(th)} < 1V
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Qsuffix) part. A listing can be found at https://www.diodes.com/products/automotive/automotive-products/.
- This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: X1-DFN1612-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202. Method 208 (4)
- Weight: 0.003 grams (approximate)

X1-DFN1612-6





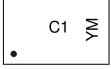
Ordering Information (Note 4)

Part Number	Case	Packaging
DMC2004LPK-7	X1-DFN1612-6	3000/Tape & Reel

Notes:

- $1. \; EU \; Directive \; 2002/95/EC \; (RoHS), \; 2011/65/EU \; (RoHS \; 2) \; \& \; 2015/863/EU \; (RoHS \; 3) \; compliant. \; All \; applicable \; RoHS \; exemptions \; applied. \\$
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



C1 = Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Year	201	2	2013		2014	20	15	2016		2017	2	2018
Code	Z		Α		В	(0	D		Е		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings N-CHANNEL – Q₁ (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain Source Voltage	V_{DSS}	20	V
Gate-Source Voltage	V _{GSS}	±8	V
Drain Current (Note 5) $ T_A = +2 $ $ T_A = +8 $	l ln	750 540	mA

Maximum Ratings P-CHANNEL - Q₂ (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain Source Voltage	V _{DSS}	-20	V
Gate-Source Voltage	V _{GSS}	±8	V
Drain Current (Note 5) $ T_{A} = +25^{\circ}C $ $ T_{A} = +85^{\circ}C $	ln.	-600 -430	mA

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_D	500	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	250	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics N-CHANNEL - Q₁ (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 10\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	± 1	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)	ON CHARACTERISTICS (Note 6)					
Gate Threshold Voltage	$V_{GS(th)}$	0.5	_	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		_	0.4	0.55		$V_{GS} = 4.5V, I_D = 540mA$
Static Drain-Source On-Resistance	R _{DS (ON)}	_	0.5	0.70	Ω	$V_{GS} = 2.5V, I_D = 500mA$
	, ,	_	0.7	0.90		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance	Y _{fs}	200	_	_	mS	$V_{DS} = 10V, I_D = 0.2A$
Diode Forward Voltage (Note 6)	V_{SD}	0.5	_	1.2	V	$V_{GS} = 0V, I_{S} = 115mA$
DYNAMIC CHARACTERISTICS	DYNAMIC CHARACTERISTICS					
Input Capacitance	C _{iss}	_	_	150	рF	
Output Capacitance	Coss	_	_	25	pF	V _{DS} = 16V, V _{GS} = 0V -f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	_	20	рF	1 - 1.0IVII IZ

Electrical Characteristics P-CHANNEL - Q₂ (@T_A = +25°C, unless otherwise specified.)

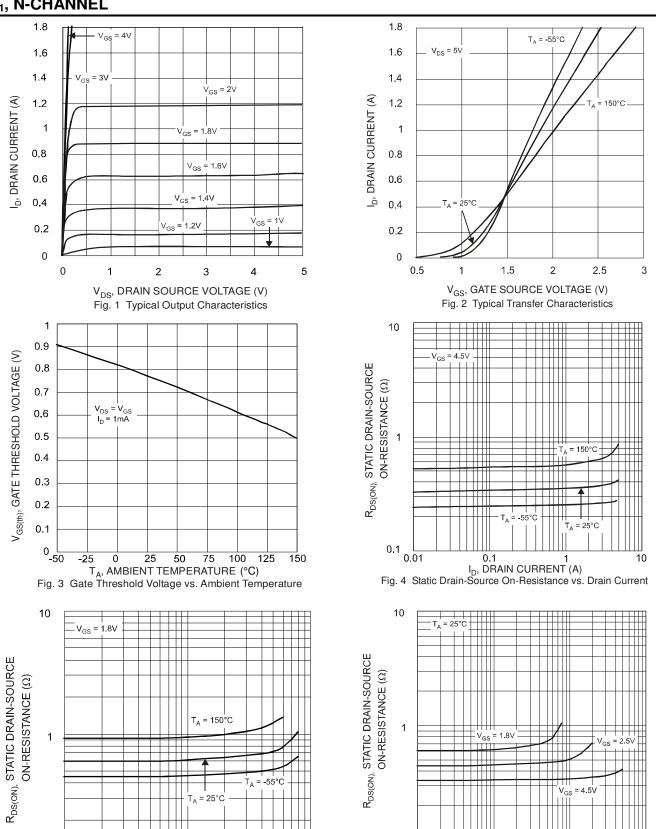
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)						•	
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	٧	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1.0	μΑ	$V_{DS} = -20V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	± 1.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	-0.5	_	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$	
			0.7	0.9		$V_{GS} = -4.5V, I_D = -430mA$	
Static Drain-Source On-Resistance	R _{DS} (ON)	_	1.1	1.4	Ω	$V_{GS} = -2.5V, I_D = -300mA$	
			1.7	2.0		$V_{GS} = -1.8V, I_D = -150mA$	
Forward Transfer Admittance	Y _{fs}	200	_	_	mS	$V_{DS} = 10V, I_D = 0.2A$	
Diode Forward Voltage (Note 5)	V _{SD}	-0.5	_	-1.2	٧	$V_{GS} = 0V, I_{S} = -115mA$	
DYNAMIC CHARACTERISTICS							
Input Capacitance	Ciss	l	_	175	рF		
Output Capacitance	Coss		_	30	рF	$V_{DS} = -16V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		_	20	pF		

Notes: 5. Device mounted on FR-4 PCB.

^{6.} Short duration pulse test used to minimize self-heating effect.



Q₁, N-CHANNEL



I_D, DRAIN CURRENT (A) Fig. 5 Static Drain-Source On-Resistance vs. Drain Current

0.1

0.1

0.1 0.01

0.1

0.01

10



Q₁, N-CHANNEL (continued)

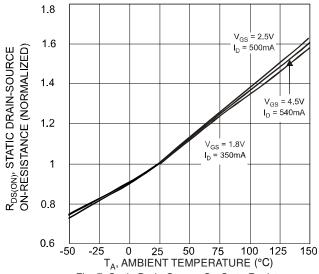


Fig. 7 Static Drain-Source On-State Resistance vs. Ambient Temperature

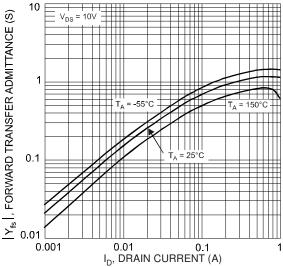


Fig. 9 Forward Transfer Admittance vs. Drain Current

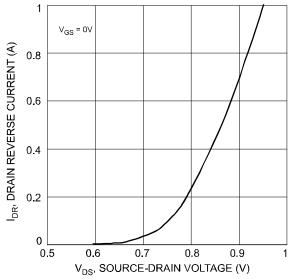
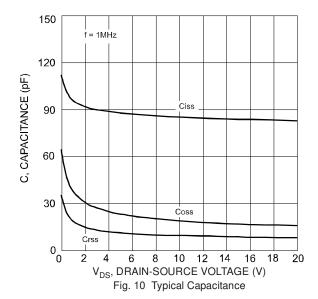


Fig. 8 Drain Reverse Current vs. Source-Drain Voltage



2.5

10



Q₂, P-CHANNEL

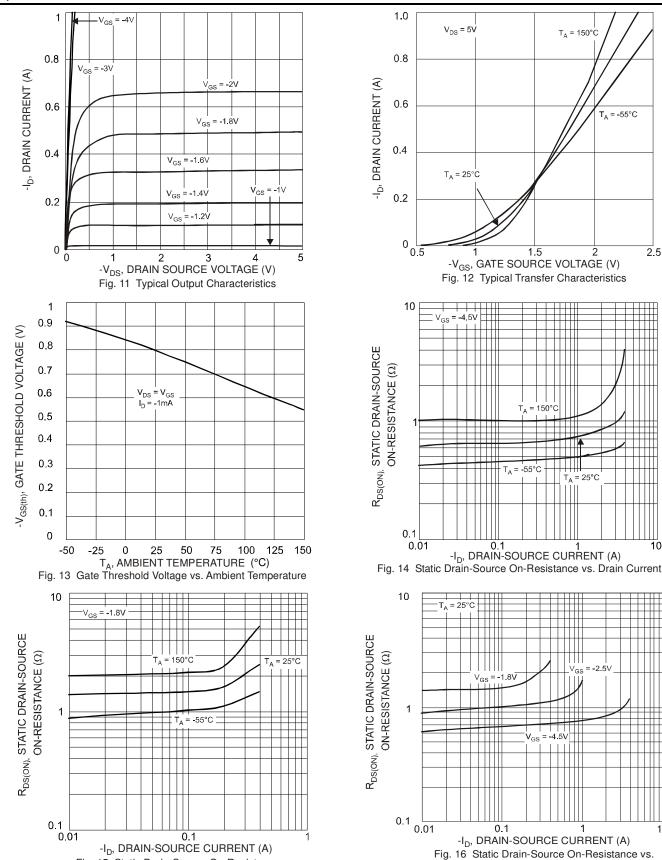


Fig. 15 Static Drain-Source On-Resistance vs.

Drain Current

Drain-Source Current vs. Gate Source Voltage

10



Q₂, P-CHANNEL (continued)

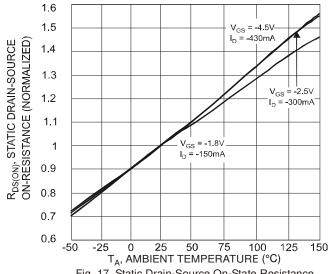


Fig. 17 Static Drain-Source On-State Resistance vs. Ambient Temperature

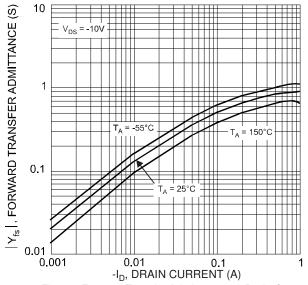


Fig. 19 Forward Transfer Admittance vs. Drain Current

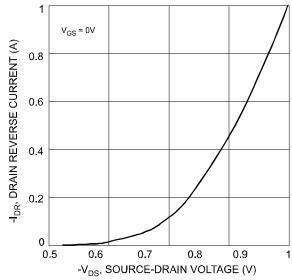
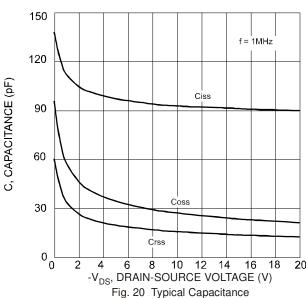


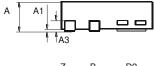
Fig. 18 Drain Reverse Current vs. Source-Drain Voltage

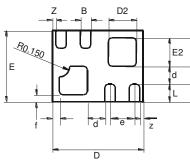




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

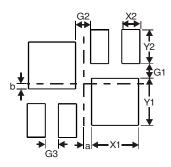




X1-DFN1612-6							
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A 1	0	0.05	0.02				
A3		_	0.13				
b	0.15	0.25	0.20				
D	1.55	1.675	1.60				
d			0.25				
D2	0.40	0.60	0.50				
Е	1.15	1.28	1.20				
е			0.40				
E2	0.45	0.65	0.55				
f	_	_	0.15				
L	0.20	0.30	0.25				
Z		_	0.10				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
G1	0.15
G2	0.175
G3	0.15
X1	0.60
X2	0.25
Y1	0.65
Y2	0.45
а	0.10
b	0.15



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